

6-23-98

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U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office  
Docket 62702  
LSI B2-4129



100757290

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
Chok J. Chia; Patrick Variot; Maniam Alagaratnam  
  
Additional name(s) of conveying party(ies) attached?  
 Yes  No

2. Name and address of receiving party(ies):  
LSI LOGIC CORPORATION  
1551 McCarthy Blvd.  
Milpitas, CA

JC135 U.S. PTO  
07/10/98  
09/10/98  
06/21/98

3. Nature of conveyance:  
  
 Assignment       Merger  
 Security Agreement     Change of Name  
 Other \_\_\_\_\_  
  
Execution Date: June 22, 1998

4. Application number(s) or patent number(s): TBD  
If this document is being filed together with a new application, the execution date of the application is: 6/22/98

A. Patent Application No.(s)  
Additional numbers attached?  Yes  No

B. Patent No.(s)

5. Name and address of party to whom correspondence concerning document should be mailed:  
  
Thomas F. Lebens  
FITCH, EVEN, TABIN & FLANNERY  
135 S. La Salle, Suite 900  
Chicago, IL 60603

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00  
 Enclosed  
 Authorized to be charged to deposit account

8. Deposit account number: 06-1135

07/07/1998 DNGUYEN 00000089 09103291  
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9. Statement and signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Thomas F. Lebens  
Name of person signing

Signature

Date: June 23, 1998

10. Total number of pages including cover sheet, attachments and document: 2

**ASSIGNMENT**

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, WE, the undersigned, Chok J. Chia, Patrick Variot and Maniam Alagaratnam, do hereby sell, assign, and transfer to: **LSI LOGIC CORPORATION**, a corporation of Delaware, having a place of business at 1551 McCarthy Boulevard, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

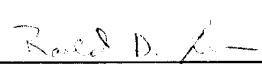
- (X) which has been executed by the undersigned concurrently herewith,
- ( ) which was filed on \_\_\_\_\_, 19\_\_ and assigned Serial Number \_\_\_\_\_.

and is entitled: **ELECTROPLATING FIXTURE FOR HIGH DENSITY SUBSTRATES** and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications to patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

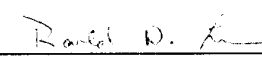
Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Name:   
Chok J. Chia

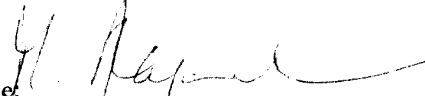
Date: June 22, 98 Witness: 

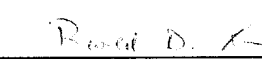
Witness: Ronald D. Lance  
Printed

Name:   
Patrick Variot

Date: June 22/98 Witness: 

Witness: Ronald D. Lance  
Printed

Name:   
Maniam Alagaratnam

Date: June 22 98 Witness: 

Witness: Ronald D. Lance  
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